

致尊敬的顾客

关于产品目录等资料中的旧公司名称

NEC电子公司与株式会社瑞萨科技于2010年4月1日进行业务整合（合并），整合后的新公司暨“瑞萨电子公司”继承两家公司的所有业务。因此，本资料中虽还保留有旧公司名称等标识，但是并不妨碍本资料的有效性，敬请谅解。

瑞萨电子公司网址：<http://www.renesas.com>

2010年4月1日
瑞萨电子公司

【发行】瑞萨电子公司（<http://www.renesas.com>）

【业务咨询】<http://www.renesas.com/inquiry>

Notice

1. All information included in this document is current as of the date this document is issued. Such information, however, is subject to change without any prior notice. Before purchasing or using any Renesas Electronics products listed herein, please confirm the latest product information with a Renesas Electronics sales office. Also, please pay regular and careful attention to additional and different information to be disclosed by Renesas Electronics such as that disclosed through our website.
2. Renesas Electronics does not assume any liability for infringement of patents, copyrights, or other intellectual property rights of third parties by or arising from the use of Renesas Electronics products or technical information described in this document. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
3. You should not alter, modify, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part.
4. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information.
5. When exporting the products or technology described in this document, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations. You should not use Renesas Electronics products or the technology described in this document for any purpose relating to military applications or use by the military, including but not limited to the development of weapons of mass destruction. Renesas Electronics products and technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations.
6. Renesas Electronics has used reasonable care in preparing the information included in this document, but Renesas Electronics does not warrant that such information is error free. Renesas Electronics assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein.
7. Renesas Electronics products are classified according to the following three quality grades: “Standard”, “High Quality”, and “Specific”. The recommended applications for each Renesas Electronics product depends on the product’s quality grade, as indicated below. You must check the quality grade of each Renesas Electronics product before using it in a particular application. You may not use any Renesas Electronics product for any application categorized as “Specific” without the prior written consent of Renesas Electronics. Further, you may not use any Renesas Electronics product for any application for which it is not intended without the prior written consent of Renesas Electronics. Renesas Electronics shall not be in any way liable for any damages or losses incurred by you or third parties arising from the use of any Renesas Electronics product for an application categorized as “Specific” or for which the product is not intended where you have failed to obtain the prior written consent of Renesas Electronics. The quality grade of each Renesas Electronics product is “Standard” unless otherwise expressly specified in a Renesas Electronics data sheets or data books, etc.
 - “Standard”: Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; and industrial robots.
 - “High Quality”: Transportation equipment (automobiles, trains, ships, etc.); traffic control systems; anti-disaster systems; anti-crime systems; safety equipment; and medical equipment not specifically designed for life support.
 - “Specific”: Aircraft; aerospace equipment; submersible repeaters; nuclear reactor control systems; medical equipment or systems for life support (e.g. artificial life support devices or systems), surgical implantations, or healthcare intervention (e.g. excision, etc.), and any other applications or purposes that pose a direct threat to human life.
8. You should use the Renesas Electronics products described in this document within the range specified by Renesas Electronics, especially with respect to the maximum rating, operating supply voltage range, movement power voltage range, heat radiation characteristics, installation and other product characteristics. Renesas Electronics shall have no liability for malfunctions or damages arising out of the use of Renesas Electronics products beyond such specified ranges.
9. Although Renesas Electronics endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Further, Renesas Electronics products are not subject to radiation resistance design. Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a Renesas Electronics product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or system manufactured by you.
10. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. Please use Renesas Electronics products in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. Renesas Electronics assumes no liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
11. This document may not be reproduced or duplicated, in any form, in whole or in part, without prior written consent of Renesas Electronics.
12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products, or if you have any other inquiries.

(Note 1) “Renesas Electronics” as used in this document means Renesas Electronics Corporation and also includes its majority-owned subsidiaries.

(Note 2) “Renesas Electronics product(s)” means any product developed or manufactured by or for Renesas Electronics.

H8/300L Super Low Power 系列

8 位 2 进制数转换为 2 位 ASCII 码

要点

将 8 位 2 进制数转换为 2 位 ASCII 码。

动作确认器件

H8/38024

目录

1. 参数	2
2. 内部寄存器变化和标志变化	2
3. 程序设计	2
4. 说明	3
4.1 功能	3
4.2 使用时的注意	3
4.3 数据存储器的说明	3
4.4 使用例	3
4.5 工作原理	4
5. 流程图	5
6. 程序清单	6

1. 参数

	内容	保存位置	数据长度（字节）
输入	8 位 2 进制数	R0L	1
输出	2 位 ASCII 码	R1	2

2. 内部寄存器变化和标志变化

R0		R1
×	×	○
R2		R3
•	×	•
R4		R5
•		•
R6		R7
•		•

I	U	H	U
•	•	×	•
N	Z	V	C
×	×	×	×

•：不变，×：不定，○：结果

3. 程序设计

	程序存储器（字节）
	38
	数据存储器（字节）
	0
	堆栈（字节）
	0
	时钟周期数
	72
	重入
	可
	再定位
	可
	中途中断
	可

4. 说明

4.1 功能

- (1) 参数的详细内容如下：
- R0L：输入参数，设定要转换为 ASCII 码的 8 位 2 进制数。
- R1：输出参数，设定将 8 位 2 进制数的高 4 位和低 4 位分别转换为 1 位 ASCII 码的数据。
- (2) 软件 COBYTE 的执行例子如图 8-1 所示。一旦如①设定输入参数，就如②设定将 8 位 2 进制数转换为 ASCII 码的数据。

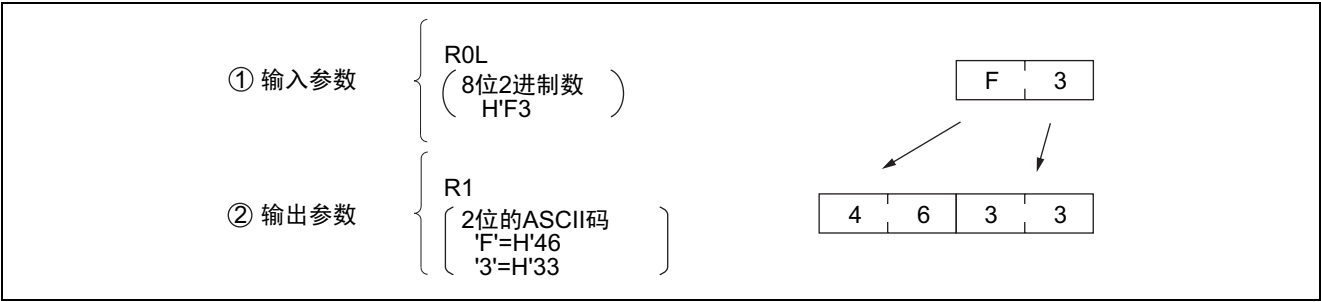


图 8-1 软件 COBYTE 的执行例子

4.2 使用时的注意

设定在 R0L 的 8 位 2 进制数在执行软件 COBYTE 后被破坏。

4.3 数据存储器的说明

软件 COBYTE 不使用数据存储器。

4.4 使用例

设定 8 位 2 进制数，子程序调用软件 COBYTE。

WORK1	.RES. B	1	确保用户程序设定8位2进制数的数据存储器区。
	.ALIGN				
WORK2	.RES. W	1	确保用户程序设定2位ASCII码的数据存储器区。
	...				
	MOV. B	@WORK1, R0L	将用户程序设定的8位2进制数设定到R0L。
	JSR	@COBYTE	子程序调用软件COBYTE。
	MOV. W	R1, @WORK2	将设定在输出参数中的2位ASCII码保存到用户程序的数据存储器区。

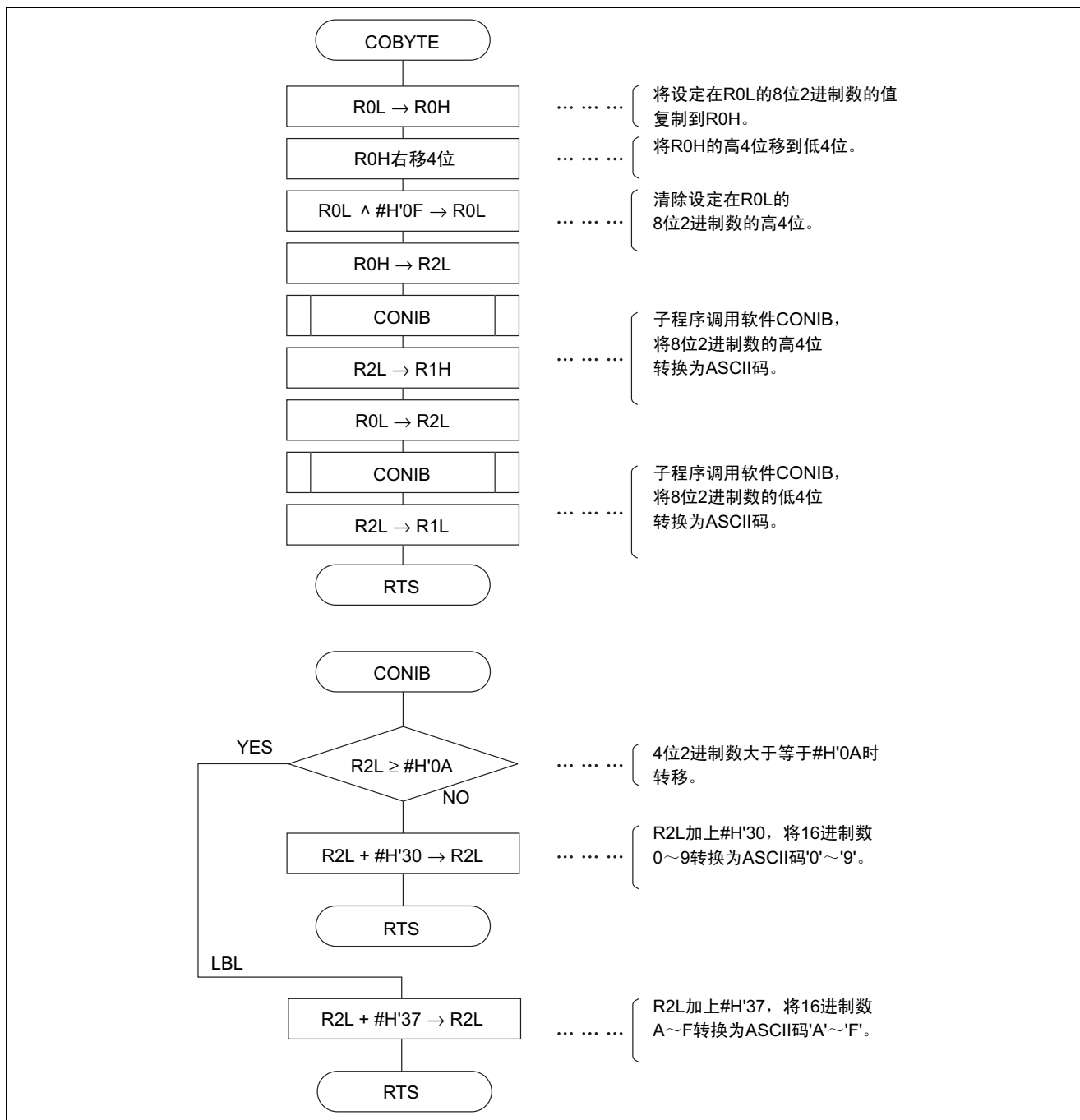
4.5 工作原理

- (1) 将设定在 R0L 的 8 位 2 进制数分为高 4 位和低 4 位。
- (2) 用比较指令 (CMP.B 指令) 判断分成的高 4 位、低 4 位数据, 数据是 H'00~H'09 (表 8-1 ASCII 码表的 的部分) 时加上 H'30; 是 H'0A~H'0F (表 8-1 ASCII 码表的 的部分) 时加上 H'37, 转换为 ASCII 码。

表 8-1 ASCII 码表

MSD \ LSD	0	1	2	3	4	5	6	7
	0 0 0	0 0 1	0 1 0	0 1 1	1 0 0	1 0 1	1 1 0	1 1 1
0 0000	NUL	DLE	SP	0	@	P	`	p
1 0001	SOH	DC1	!	1	A	Q	a	q
2 0010	STX	DC2	"	2	B	R	b	r
3 0011	ETX	DC3	#	3	C	S	c	s
4 0100	EOT	DC4	\$	4	D	T	d	t
5 0101	ENG	NAK	%	5	E	U	e	u
6 0110	ACK	SYN	&	6	F	V	f	v
7 0111	BEL	ETB	'	7	G	W	g	w
8 1000	BS	CAN	(8	H	X	h	x
9 1001	HT	EM)	9	I	Y	i	y
A 1010	LF	SUB	*	:	J	Z	j	z
B 1011	VT	ESC	+	;	K	[k	{
C 1100	FF	FS	,	<	L	\	l	
D 1101	CR	GS	-	=	M]	m	}
E 1110	SO	RS	•	>	N	↑	n	~
F 1111	SI	VS	/	?	O	←	o	DEL

5. 流程图



6. 程序清单

```

*** H8/300 ASSEMBLER      VER 1.0B **    08/18/92 09:49:53
PROGRAM NAME =

1          ;*****
2          ;*
3          ;*      00 - NAME                      :CHANGE 1 BYTE HEXADECIMAL
4          ;*                                           TO 2 BYTE ASCII CODE (COBYTE)
5          ;*
6          ;*****
7          ;*
8          ;*      ENTRY          :R0L              (1 BYTE HEXADECIMAL)
9          ;*
10         ;*      RETURN         :R1              (2 BYTE ASCII CODE)
11         ;*
12         ;*****
13         ;
14 COBYTE_c C 0000          .SECTION          COBYTE_code, CODE, ALIGN=2
15                               .EXPORT          COBYTE
16         ;
17 COBYTE_c C      00000000 COBYTE          .EQU      $          ;Entry Point
18 COBYTE_c C 0000 0C80          MOV.B      R0L,R0H
19         ;
20 COBYTE_c C 0002 1100          SHLR      R0H
21 COBYTE_c C 0004 1100          SHLR      R0H
22 COBYTE_c C 0006 1100          SHLR      R0H
23 COBYTE_c C 0008 1100          SHLR      R0H          ;Select upper 4 bit hexadecimal(R0H)
24         ;
25 COBYTE_c C 000A E80F          AND.B      #H'0F,R0L          ;Select lower 4 bit hexadecimal(R0L)
26         ;
27 COBYTE_c C 000C 0C0A          MOV.B      R0H,R2L
28 COBYTE_c C 000E 550A          BSR      CONIB          ;Branch subroutine CONIB
29 COBYTE_c C 0010 0CA1          MOV.B      R2L,R1H          ;Set 1st ASCII code to R1H
30         ;
31 COBYTE_c C 0012 0C8A          MOV.B      R0L,R2L
32 COBYTE_c C 0014 5504          BSR      CONIB          ;Branch subroutine CONIB
33 COBYTE_c C 0016 0CA9          MOV.B      R2L,R1L          ;Set 2nd ASCII code to R1L
34 ;
35 COBYTE_c C 0018 5470          RTS
36         ;-----
37 COBYTE_c C 001A          CONIB          ;Change R2L to ASCII code
38 COBYTE_c C 001A AA0A          CMP.B      #H'0A,R2L
39 COBYTE_c C 001C 4404          BCC      LBL          ;Branch if R2L ASCII "A"- "F"
40 COBYTE_c C 001E 8A30          ADD.B      #H'30,R2L          ;Reshape R2L ASCII "0"- "9"
41 COBYTE_c C 0020 5470          RTS
42 COBYTE_c C 0022          LBL
43 COBYTE_c C 0022 8A37          ADD.B      #H'37,R2L
44 COBYTE_c C 0024 5470          RTS
45         ;
46         .END
*****TOTAL ERRORS      0
*****TOTAL WARNINGS    0

```


修订记录

Rev.	发行日	修订内容	
		页	修订要点
1.00	2005.07.29	—	初版发行

Cautions

Keep safety first in your circuit designs!

1. Renesas Technology Corp. puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage.
Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or (iii) prevention against any malfunction or mishap.

Notes regarding these materials

1. These materials are intended as a reference to assist our customers in the selection of the Renesas Technology Corp. product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Renesas Technology Corp. or a third party.
2. Renesas Technology Corp. assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials.
3. All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Renesas Technology Corp. without notice due to product improvements or other reasons. It is therefore recommended that customers contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor for the latest product information before purchasing a product listed herein.
The information described here may contain technical inaccuracies or typographical errors.
Renesas Technology Corp. assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors.
Please also pay attention to information published by Renesas Technology Corp. by various means, including the Renesas Technology Corp. Semiconductor home page (<http://www.renesas.com>).
4. When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information and products. Renesas Technology Corp. assumes no responsibility for any damage, liability or other loss resulting from the information contained herein.
5. Renesas Technology Corp. semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeater use.
6. The prior written approval of Renesas Technology Corp. is necessary to reprint or reproduce in whole or in part these materials.
7. If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination.
Any diversion or reexport contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited.
8. Please contact Renesas Technology Corp. for further details on these materials or the products contained therein.

注意

本文只是参考译文，前页所载英文版“Cautions”具有正式效力。

请遵循安全第一进行电路设计

1. 虽然瑞萨科技尽力提高半导体产品的质量和可靠性，但是半导体产品也可能发生故障。半导体的故障可能导致人身伤害、火灾事故以及财产损害。在电路设计时，请充分考虑安全性，采用合适的如冗余设计、利用非易燃材料以及故障或者事故防止等的安全设计方法。

关于利用本资料时的注意事项

1. 本资料是为了让用户根据用途选择合适的瑞萨科技产品的参考资料，不转让属于瑞萨科技或者第三者所有的知识产权和其它权利的许可。
2. 对于因使用本资料所记载的产品数据、图、表、程序、算法以及其它应用电路的例子而引起的损害或者对第三者的权力的侵犯，瑞萨科技不承担责任。
3. 本资料所记载的产品数据、图、表、程序、算法以及其它所有信息均为本资料发行时的信息，由于改进产品或者其它原因，本资料记载的信息可能变动，恕不另行通知。在购买本资料所记载的产品时，请预先向瑞萨科技或者经授权的瑞萨科技产品经销商确认最新信息。
本资料所记载的信息可能存在技术不准确或者印刷错误。因这些错误而引起的损害、责任问题或者其它损失，瑞萨科技不承担责任。
同时也请通过各种方式注意瑞萨科技公布的信息，包括瑞萨科技半导体网站。
(<http://www.renesas.com>)
4. 在使用本资料所记载部分或者全部数据、图、表、程序以及算法等信息时，在最终做出有关信息和产品是否适用的判断前，务必对作为整个系统的所有信息进行评价。由于本资料所记载的信息而引起的损害、责任问题或者其它损失，瑞萨科技不承担责任。
5. 瑞萨科技的半导体产品不是为在可能和人命相关的环境下使用的设备或者系统而设计和制造的产品。在研讨将本资料所记载的产品用于运输、交通车辆、医疗、航空宇宙用、原子能控制、海底中继器的设备或者系统等特殊用途时，请与瑞萨科技或者经授权的瑞萨产品经销商联系。
6. 未经瑞萨科技的书面许可，不得翻印或者复制全部或者部分资料的内容。
7. 如果本资料所记载的某产品或者技术内容受日本出口管理限制，必须在得到日本政府的有关部门许可后才能出口，并且不准进口到批准目的地国家以外的国家。
禁止违反日本和（或者）目的地国家的出口管理法和法规的任何转卖、挪用或者再出口。
8. 如果需要了解本资料所记载的信息或者产品的详细，请与瑞萨科技联系。